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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WON JUN LEE	10/08/2013
DONG PHIL LIM	10/08/2013
HYE YOUN CHUNG	10/08/2013
SE HYUN KIM	10/08/2013

RECEIVING PARTY DATA

Name:	SK PLANET CO., LTD.	
Street Address:	11, EULJIRO 2-GA, JUNG-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	100-999	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14007851

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	110989-0055
NAME OF SUBMITTER:	YOON S. HAM

PATENT

REEL: 031436 FRAME: 0153 502537978

Signature:	/Yoon S. Ham/
Date:	10/18/2013
Total Attachments: 1 source=110989-0055_Assignment#page1.tif	

PATENT REEL: 031436 FRAME: 0154

Docket No.: 110989-0055

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) LEE, Won Jun
- 3) CHUNG, Hye Youn
- 2) LIM, Dong Phil
- 4) KIM, Se Hyun
 - x box if continued on page 2

who has made a certain new and useful invention, hereby sells, assigns and transfers unto SK PLANET CO., LTD. having a place of business at 11, Euljiro 2-ga, Jung-gu, Seoul 100-999, Republic of Korea, its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

ELECTRONIC PAYMENT METHOD, SYSTEM, AND DEVICE

- (a) for which an application for United States Letters Patent was filed on September 26, 2013, and identified by United States Patent Application No. 14/007,851; or

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature.

1)______

Name: LEE, Won Jun

Name: LIM Dong Phil

Name: CHUNG, Hye Youn

Name: KIM. Se Hviin

2013.10.8

Date

20/3.10. P

Date

2013.10.8

Date

2013, 10.8

Date

PATENT REEL: 031436 FRAME: 0155

RECORDED: 10/18/2013